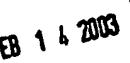


MPEP

 FORM PTO 1449 US Department of Commerce Patent and Trademark Office	ATTY DOCKET NO.: VIGN1260-1	SERIAL NO.: 09/681,760
	APPLICANT(S): Sean M. McCullough	
INFORMATION DISCLOSURE STATEMENT BY APPLICANT	FILING DATE: May 31, 2001	GROUP ART UNIT: 2152

U.S. PATENT DOCUMENTS

EXAM. INITIALS		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB- CLASS	FILING DATE	
(AP)	A1	5,790,790	08/04/98	Smith et al.	395	200	10/24/96	
(AP)	A2	5,774,660	06/30/98	Brendel et al.	395	200	08/05/96	
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EXAMINER



DATE CONSIDERED

1/13/2004

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.